16-bit buffer/line driver with 5 V tolerant inputs/outputs; 3-state

Rev. 4 — 26 October 2011

Product data sheet

1. General description

The 74LVC16241A is a 16-bit non-inverting buffer/line driver with 3-state outputs. The 3-state outputs are controlled by the output enable inputs ($\overline{10E}$, 20E, 30E and $\overline{40E}$). Schmitt trigger action at all inputs makes the circuit highly tolerant of slower input rise and fall times. The device can be used as four 4-bit buffers, two 8-bit buffers or one 16-bit buffer.

Inputs can be driven from either 3.3 V or 5 V devices. When disabled, up to 5.5 V can be applied to the outputs. These features allow the use of these devices in mixed 3.3 V and 5 V applications.

2. Features and benefits

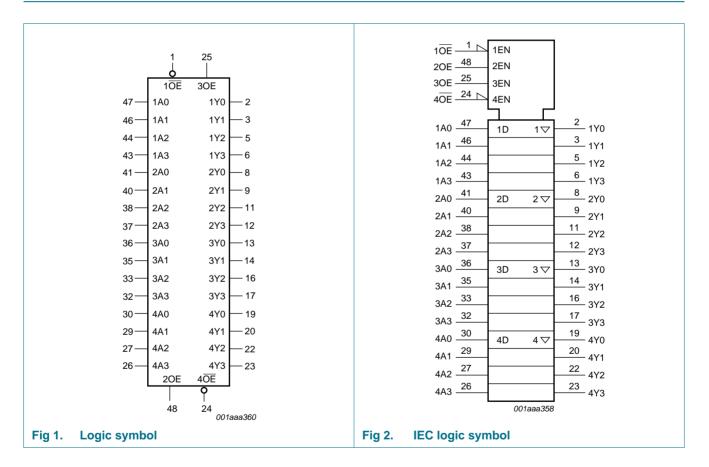
- 5 V tolerant inputs and outputs for interfacing with 5 V logic
- Wide supply voltage range from 1.2 V to 3.6 V
- CMOS low power consumption
- MULTIBYTE flow-through standard pin-out architecture
- Low inductance multiple power and ground pins for minimum noise and ground bounce
- Direct interface with TTL levels
- High-impedance outputs when V_{CC} = 0 V
- Complies with JEDEC standard:
 - JESD8-7A (1.65 V to 1.95 V
 - JESD8-5A (2.3 V to 2.7 V
 - ◆ JESD8-C/JESD36 (2.7 V to 3.6 V
- ESD protection:
 - HBM JESD22-A114F exceeds 2000 V
 - MM JESD22-A115B exceeds 200 V
 - CDM JESD22-C101E exceeds 1000 V
- Specified from -40 °C to +85 °C and -40 °C to +125 °C.



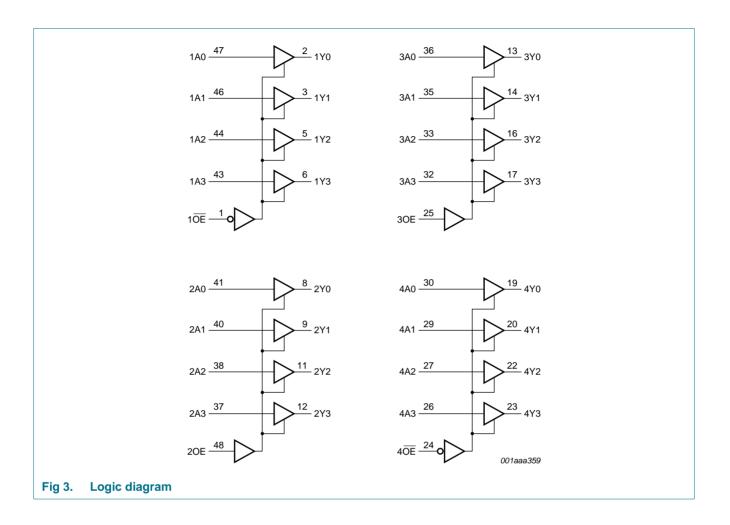
3. Ordering information

Table 1. Ordering	Table 1. Ordering information											
Type number Package												
	Temperature range	Name	Description	Version								
74LVC16241ADL	–40 °C to +125 °C	SSOP48	plastic shrink small outline package; 48 leads; body width 7.5 mm	SOT370-1								
74LVC16241ADGG	–40 °C to +125 °C	TSSOP48	plastic thin shrink small outline package; 48 leads; body width 6.1 mm	SOT362-1								

4. Functional diagram



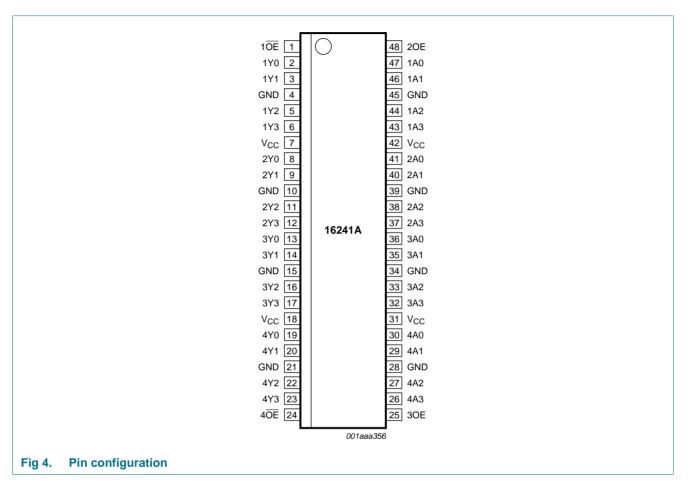
16-bit buffer/line driver with 5 V tolerant inputs/outputs; 3-state



16-bit buffer/line driver with 5 V tolerant inputs/outputs; 3-state

5. Pinning information

5.1 Pinning



5.2 Pin description

Table 2.	Pin description
Name	Pin

Name	Pin	Description
1 0E	1	output enable input (active LOW)
2OE	48	output enable input (active HIGH)
30E	25	output enable input (active HIGH)
4 0E	24	output enable input (active LOW)
GND	4, 10, 15, 21, 28, 34, 39, 45	ground (0 V)
V _{CC}	7, 18, 31, 42	supply voltage
1Y[0:3]	2, 3, 5, 6	data output
2Y[0:3]	8, 9, 11, 12	data output
3Y[0:3]	13, 14, 16, 17	data output
4Y[0:3]	19, 20, 22, 23	data output
1A[0:3]	47, 46, 44, 43	data input

74LVC16241A

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Table 2.	Pin description continued		
Name	Pin	Description	
2A[0:3]	41, 40, 38, 37	data input	
3A[0:3]	36, 35, 33, 32	data input	
4A[0:3]	30, 29, 27, 26	data input	

6. Functional description

Input			Output
nAn	nOE	nOE	nYn
Н	L	-	Н
	-	Н	Н
L	L	-	L
	-	Н	L
Х	Н	-	Z
	-	L	Z

[1] H = HIGH voltage level

L = LOW voltage level

X = don't care

Z = high-impedance OFF-state

7. Limiting values

Table 4.Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

		0, 1, ,	0		10	,
Symbol	Parameter	Conditions		Min	Max	Unit
V _{CC}	supply voltage			-0.5	+6.5	V
I _{IK}	input clamping current	V _I < 0 V		-50	-	mA
VI	input voltage		<u>[1]</u>	-0.5	+6.5	V
Ι _{ΟΚ}	output clamping current	$V_{\rm O}$ > $V_{\rm CC}$ or $V_{\rm O}$ < 0 V		-	±50	mA
Vo	output voltage	HIGH or LOW state	[2]	-0.5	V _{CC} + 0.5	V
		3-state	[2]	-0.5	+6.5	V
lo	output current	$V_{O} = 0 V$ to V_{CC}		-	±50	mA
I _{CC}	supply current			-	100	mA
I _{GND}	ground current			-100	-	mA
T _{stg}	storage temperature			-65	+150	°C
P _{tot}	total power dissipation	T_{amb} = -40 °C to +125 °C	<u>[3]</u>	-	500	mW

[1] The minimum input voltage ratings may be exceeded if the input current ratings are observed.

[2] The output voltage ratings may be exceeded if the output current ratings are observed.

[3] Above 60 °C the value of P_{tot} derates linearly with 5.5 mW/K.

8. Recommended operating conditions

Table 5.	Recommended operating cond	Recommended operating conditions						
Symbol	Parameter	Conditions	Min	Тур	Max	Unit		
V _{CC}	supply voltage		1.65	-	3.6	V		
		functional	1.2	-	-	V		
VI	input voltage		0	-	5.5	V		
Vo	output voltage	HIGH or LOW state	0	-	V _{CC}	V		
		3-state	0	-	5.5	V		
T _{amb}	ambient temperature	in free air	-40	-	+125	°C		
$\Delta t / \Delta V$	input transition rise and fall rate	V_{CC} = 1.65 V to 2.7 V	0	-	20	ns/V		
		V_{CC} = 2.7 V to 3.6 V	0	-	10	ns/V		

9. Static characteristics

Table 6. Static characteristics

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	-40	−40 °C to +85 °C			–40 °C to +125 °C		
			Min	Typ <mark>[1]</mark>	Мах	Min	Max	1	
VIH	HIGH-level	V _{CC} = 1.2 V	1.08	-	-	1.08	-	V	
	input voltage	V_{CC} = 1.65 V to 1.95 V	$0.65 \times V_{CC}$	-	-	$0.65 \times V_{CC}$	-	V	
		V_{CC} = 2.3 V to 2.7 V	1.7	-	-	1.7	-	V	
		V_{CC} = 2.7 V to 3.6 V	2.0	-	-	2.0	-	V	
V _{IL}	LOW-level	V _{CC} = 1.2 V	-	-	0.12	-	0.12	V	
	input voltage	V_{CC} = 1.65 V to 1.95 V	-	-	$0.35 \times V_{CC}$	-	$0.35 \times V_{CC}$	V	
		V_{CC} = 2.3 V to 2.7 V	-	-	0.7	-	0.7	V	
		V_{CC} = 2.7 V to 3.6 V	-	-	0.8	-	0.8	V	
/ _{ОН}	HIGH-level	$V_{I} = V_{IH} \text{ or } V_{IL}$							
	output voltage	$I_{O} = -100 \ \mu A;$ $V_{CC} = 1.65 \ V \text{ to } 3.6 \ V$	$V_{CC}-0.2$	-	-	$V_{CC}-0.3$	-	V	
		$I_{O} = -4 \text{ mA}; V_{CC} = 1.65 \text{ V}$	1.2	-	-	1.05	-	V	
		$I_{O} = -8 \text{ mA}; V_{CC} = 2.3 \text{ V}$	1.8	-	-	1.65	-	V	
		$I_0 = -12 \text{ mA}; V_{CC} = 2.7 \text{ V}$	2.2	-	-	2.05	-	V	
		$I_{O} = -18 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.4	-	-	2.25	-	V	
		$I_O = -24$ mA; $V_{CC} = 3.0$ V	2.2	-	-	2.0	-	V	
/ _{OL}	LOW-level	$V_{I} = V_{IH} \text{ or } V_{IL}$							
	output voltage	I _O = 100 μA; V _{CC} = 1.65 V to 3.6 V	-	-	0.2	-	0.3	V	
		$I_{O} = 4 \text{ mA}; V_{CC} = 1.65 \text{ V}$	-	-	0.45	-	0.65	V	
		I_{O} = 8 mA; V_{CC} = 2.3 V	-	-	0.6	-	0.8	V	
		$I_0 = 12 \text{ mA}; V_{CC} = 2.7 \text{ V}$	-	-	0.4	-	0.6	V	
		$I_0 = 24 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	-	0.55	-	0.8	V	
I	input leakage current	V_{CC} = 3.6 V; V_{I} = 5.5 V or GND	-	±0.1	±5	-	±20	μA	

Table 6. Static characteristics ... continued

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

	•	0			,			
Symbol	Parameter	Conditions	−40 °C to +85 °C		-40 °C te	o +125 °C	Unit	
			Min	Typ <mark>[1]</mark>	Max	Min	Max	
I _{OZ}	OFF-state output current	$V_{I} = V_{IH} \text{ or } V_{IL}; V_{CC} = 3.6 \text{ V}; \\ V_{O} = 5.5 \text{ V or GND};$	-	±0.1	±5	-	±20	μΑ
I _{OFF}	power-off leakage current	V_{CC} = 0 V; V _I or V _O = 5.5 V	-	±0.1	±10	-	±20	μΑ
I _{CC}	supply current	$\label{eq:V_CC} \begin{array}{l} V_{CC} = 3.6 \ V; \ V_{I} = V_{CC} \ \text{or GND}; \\ I_{O} = 0 \ A \end{array}$	-	0.1	20	-	80	μΑ
ΔI_{CC}	additional supply current	per inputpin; V _{CC} = 2.7 V to 3.6 V; V _I = V _{CC} - 0.6 V; I _O = 0 A	-	5	500	-	5000	μΑ
CI	input capacitance	$V_{CC} = 0 V \text{ to } 3.6 V;$ $V_{I} = GND \text{ to } V_{CC}$	-	5.0	-	-	-	pF

[1] All typical values are measured at V_{CC} = 3.3 V (unless stated otherwise) and T_{amb} = 25 °C.

10. Dynamic characteristics

Table 7.Dynamic characteristics

Voltages are referenced to GND (ground = 0 V). For test circuit see Figure 8.

Symbol	Parameter	Conditions		T _{amb} =	–40 °C to	• +85 °C	-40 °C to	o +125 °C	Unit
				Min	Typ <mark>[1]</mark>	Max	Min	Max	
P#	propagation	nAn to nYn; see Figure 5	[2]						
	delay	$V_{CC} = 1.2 V$		-	13	-	-	-	ns
		V_{CC} = 1.65 V to 1.95 V		1.7	4.8	10.1	1.7	11.7	ns
		V_{CC} = 2.3 V to 2.7 V		1.5	2.6	5.3	1.5	6.1	ns
		$V_{CC} = 2.7 V$		1.0	2.6	5.0	1.0	6.5	ns
		V_{CC} = 3.0 V to 3.6 V		1.0	2.2	4.4	1.0	5.5	ns
t _{en}	enable time	n <mark>OE</mark> to nYn; see <u>Figure 6</u>	[2]						
		$V_{CC} = 1.2 V$		-	17	-	-	-	ns
		V_{CC} = 1.65 V to 1.95 V		1.0	5.2	12.5	1.0	13.2	ns
		V_{CC} = 2.3 V to 2.7 V		1.0	3.0	6.9	1.0	7.3	ns
		$V_{CC} = 2.7 V$		1.0	3.2	6.0	1.0	7.5	ns
		V_{CC} = 3.0 V to 3.6 V		1.0	2.4	5.5	1.0	7.0	ns
		nOE to nYn; see Figure 7							
		$V_{CC} = 1.2 V$		-	19	-	-	-	ns
		V_{CC} = 1.65 V to 1.95 V		2.5	6.9	14.2	2.5	15.0	ns
		V_{CC} = 2.3 V to 2.7 V		2.1	3.9	7.5	2.1	8.3	ns
		$V_{CC} = 2.7 V$		1.5	3.3	6.0	1.5	7.5	ns
		V_{CC} = 3.0 V to 3.6 V		1.5	3.1	5.5	1.5	7.0	ns

Table 7. Dynamic characteristics ...continued

Voltages are referenced to GND (ground = 0 V). For test circuit see Figure 8.

Symbol	Parameter	Conditions	-	T _{amb} =	–40 °C to	+85 °C	–40 °C to	o +125 °C	Unit
				Min	Typ[1]	Max	Min	Max	
t _{dis}	disable time	nOE to nYn; see Figure 6	[2]		•				
		$V_{CC} = 1.2 V$		-	9.0	-	-	-	ns
		$V_{CC} = 1.65 \text{ V}$ to 1.95 V		2.4	4.3	8.3	2.4	9.2	ns
		V_{CC} = 2.3 V to 2.7 V		1.0	2.4	4.7	1.0	5.2	ns
		$V_{CC} = 2.7 V$		1.5	3.2	5.5	1.5	7.0	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		1.5	3.0	5.0	1.5	6.5	ns
	nOE to nYn; see Figure 7								
		$V_{CC} = 1.2 V$		-	8.0	-	-	-	ns
		$V_{CC} = 1.65 \text{ V}$ to 1.95 V		1.5	3.5	8.4	1.5	9.6	ns
		V_{CC} = 2.3 V to 2.7 V		0.5	1.9	4.8	0.5	5.5	ns
		$V_{CC} = 2.7 V$		1.5	3.5	5.5	1.5	7.0	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		1.0	2.6	5.0	1.0	6.5	ns
C _{PD} power		per input; $V_I = GND$ to V_{CC}	<u>[3]</u>						
	dissipation	V_{CC} = 1.65 V to 1.95 V		-	8.4	-	-	-	pF
	capacitance	V_{CC} = 2.3 V to 2.7 V		-	11.9	-	-	-	pF
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		-	15.0	-	-	-	pF

[1] Typical values are measured at T_{amb} = 25 °C and V_{CC} = 1.2 V, 1.8 V, 2.5 V, 2.7 V, and 3.3 V respectively.

[3] C_{PD} is used to determine the dynamic power dissipation (P_D in μ W).

 $\mathsf{P}_{\mathsf{D}} = \mathsf{C}_{\mathsf{P}\mathsf{D}} \times \mathsf{V}_{\mathsf{C}\mathsf{C}}{}^2 \times \mathsf{f}_i \times \mathsf{N} + \Sigma(\mathsf{C}_{\mathsf{L}} \times \mathsf{V}_{\mathsf{C}\mathsf{C}}{}^2 \times \mathsf{f}_{o}) \text{ where:}$

 f_i = input frequency in MHz; f_o = output frequency in MHz

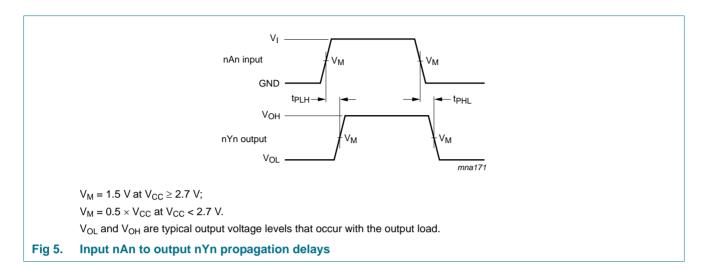
 C_L = output load capacitance in pF

 V_{CC} = supply voltage in Volts

N = number of inputs switching

 $\Sigma(C_L \times V_{CC}^2 \times f_o)$ = sum of the outputs

11. Waveforms



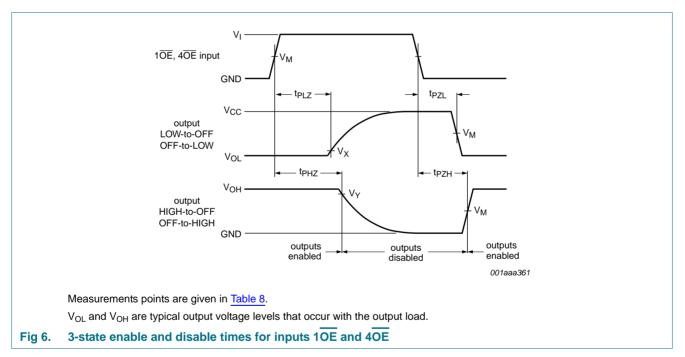


Table 8. Measurement points

Supply voltage	Input	Output	Output						
V _{CC}	V _M	V _M	V _X	V _Y					
1.2 V	$0.5 imes V_{CC}$	$0.5\times V_{CC}$	V _{OL} + 0.15 V	V _{OH} – 0.15 V					
1.65 V to 1.95 V	$0.5\times V_{CC}$	$0.5\times V_{CC}$	V _{OL} + 0.15 V	V _{OH} – 0.15 V					
2.3 V to 2.7 V	$0.5\times V_{CC}$	$0.5\times V_{CC}$	V _{OL} + 0.15 V	V _{OH} – 0.15 V					
2.7 V	1.5 V	1.5 V	V _{OL} + 0.3 V	V _{OH} – 0.3 V					
3.0 V to 3.6 V	1.5 V	1.5 V	V _{OL} + 0.3 V	V _{OH} – 0.3 V					

16-bit buffer/line driver with 5 V tolerant inputs/outputs; 3-state

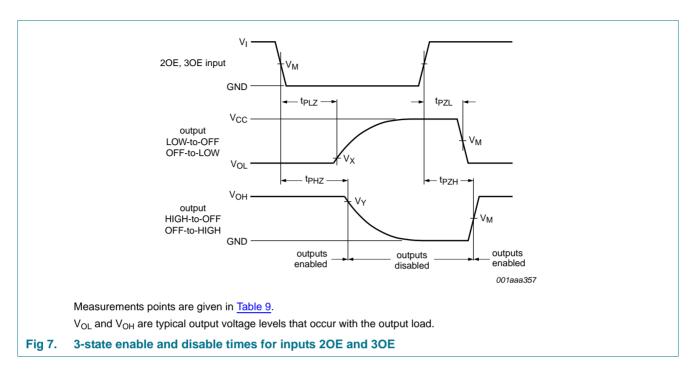
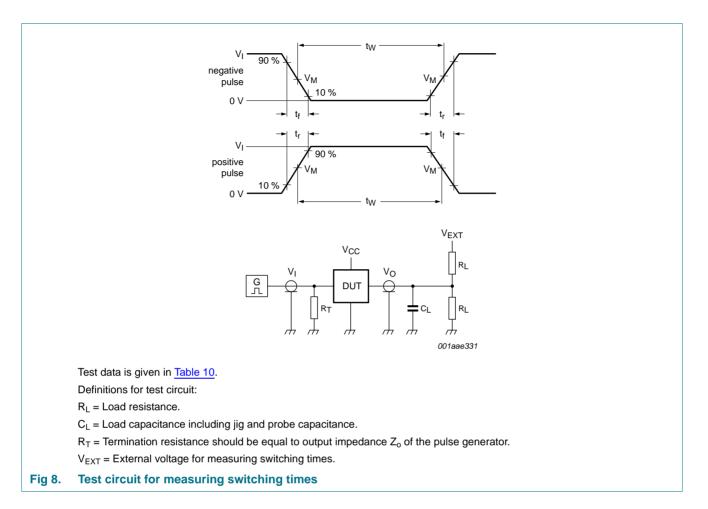


Table 9. Measurement points

Supply voltage	Input	Output			
V _{CC}	V _M	V _M	V _X	V _Y	
1.2 V	$0.5 imes V_{CC}$	$0.5\times V_{CC}$	V _{OL} + 0.15 V	V _{OH} – 0.15 V	
1.65 V to 1.95 V	$0.5\times V_{CC}$	$0.5\times V_{CC}$	V _{OL} + 0.15 V	V _{OH} – 0.15 V	
2.3 V to 2.7 V	$0.5\times V_{CC}$	$0.5\times V_{CC}$	V _{OL} + 0.15 V	V _{OH} – 0.15 V	
2.7 V	1.5 V	1.5 V	V _{OL} + 0.3 V	V _{OH} – 0.3 V	
3.0 V to 3.6 V	1.5 V	1.5 V	V _{OL} + 0.3 V	V _{OH} – 0.3 V	

16-bit buffer/line driver with 5 V tolerant inputs/outputs; 3-state



Tabl	e 10). '	Test	data

Supply voltage	Input		Load	Load		V _{EXT}		
	VI	t _r , t _f	CL	RL	t _{PLH} , t _{PHL}	t _{PLZ} , t _{PZL}	t _{PHZ} , t _{PZH}	
1.2 V	V _{CC}	\leq 2 ns	30 pF	1 kΩ	open	$2 \times V_{CC}$	GND	
1.65 V to 1.95 V	V _{CC}	\leq 2 ns	30 pF	1 kΩ	open	$2 \times V_{CC}$	GND	
2.3 V to 2.7 V	V _{CC}	\leq 2 ns	30 pF	500 Ω	open	$2 \times V_{CC}$	GND	
2.7 V	2.7 V	\leq 2.5 ns	50 pF	500 Ω	open	$2\times V_{CC}$	GND	
3.0 V to 3.6 V	2.7 V	\leq 2.5 ns	50 pF	500 Ω	open	$2\times V_{CC}$	GND	

12. Package outline

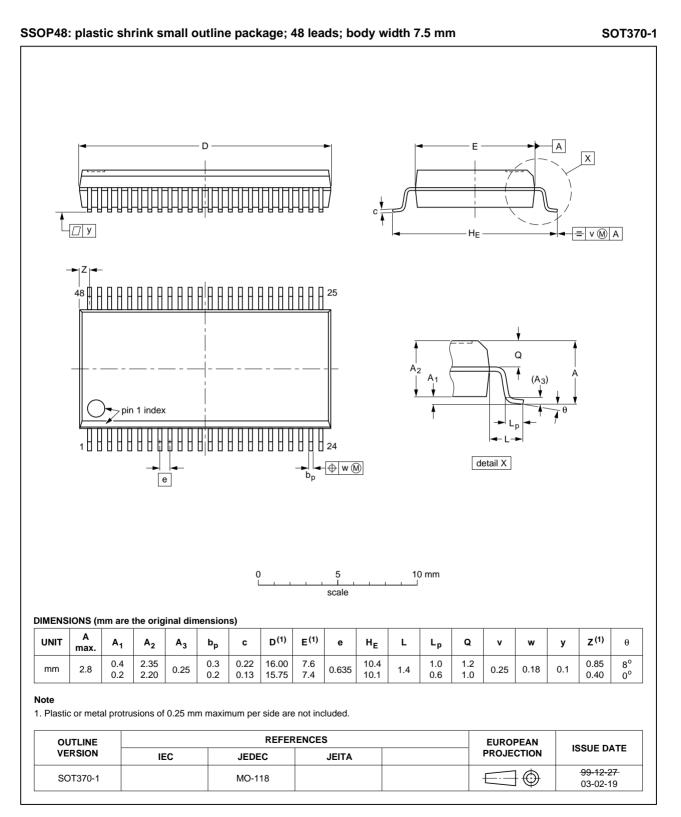


Fig 9. Package outline SOT370-1 (SSOP48)

16-bit buffer/line driver with 5 V tolerant inputs/outputs; 3-state

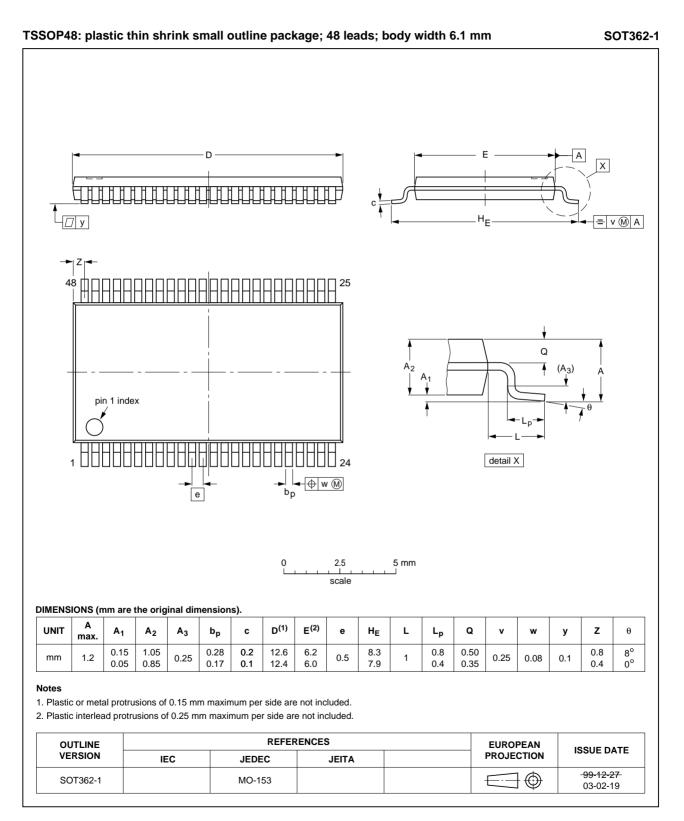


Fig 10. Package outline SOT362-1 (TSSOP48)

13. Abbreviations

Table 11.	Abbreviations
Acronym	Description
CDM	Charged Device Model
DUT	Device Under Test
ESD	ElectroStatic Discharge
HBM	Human Body Model
MM	Machine Model
TTL	Transistor-Transistor Logic

14. Revision history

Table 12. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes		
74LVC16241A v.4	20111026	Product data sheet	-	74LVC16241A v.3		
Modifications: • The format of this document has been redesigned to comply with the new identity g NXP Semiconductors.				he new identity guidelines of		
	 Legal texts have been adapted to the new company name where appropriate. 					
	• Table 4, Table	5, Table 6, Table 7, and Tabl	e 10: values added for	lower voltage ranges.		
74LVC16241A v.3	20040305	Product specification	-	74LVC16241A v.2		
74LVC16241A v.2	19970729	Product specification	-	74LVC16241A v.1		
74LVC16241A v.1	19951226	Product specification	-	-		

15. Legal information

15.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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